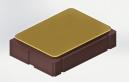
**S73** 

## SERIES - 100 krad SI

Crystal Oscillator | 3.3V | CMOS | 5x7mm Ceramic SMD | Space Grade



5x7 mm Ceramic SMD Package



Features

Ruggedized Design
High-Shock & Vibration
Industry Standard Package

Shortest Lead Time Smallest Hi-Rel Package ECCN - EAR 99

Best Stability Over Temperature
Customer Support & Service
See S74 Datasheet for 5V Operation

Robust, Rugged, High Shock Crystal Support (3 or 4 point Crystal Mount)

### **Electrical SPECIFICATIONS**

EM	Dash Numb EQM	er FM	Frequency Range (MHz)	Supply Current @ 3.3V ±10% (mA)	Rise/Fall Time (tr/tf) max (nsec)	Symmetry min / max (%)	Aging per year max 1/ (ppm)	Stability of -55°C to +125°C (ppm)	ver Operatin -55°C to +125°C (ppm)	g Tempera -40°C to +85°C (ppm)	ture Range -20°C to +70°C (ppm)
CODE	CODE	CODE						CODE A*	CODE B	CODE	CODE
01	02	03	0.25 to 0.9	6	3	48/52	±10	±50	±65	±40	±30
04	05	06	1 to 7.9	6	3	48/52	±10	±50	±65	±40	±30
07	08	09	8 to 15.9	10	3	45/55	±10	±50	±65	±40	±30
11	12	13	16 to 49.9	15	3	45/55	±10	±50	±65	±40	±30
14	15	16	50 to 64.9	15	2	40/60	±10	±50	±65	±40	±30
17	18	19	65 to 84.9	27	2	40/60	±10	±50	±65	±40	±30
21	22	23	85 to 135	27	2	40/60	±10	±50	±65	±40	±30

Please Contact Us for Specification Options that are Outside of or beyond those Shown in the Table Above

**Standard MODEL TYPES** 

CMOS Output, 10 kΩ || 15 pF Load
Output Voltage - Logic "0" is Vcc x 0.1 Vdc
Output Voltage - Logic "1" is Vcc is 0.9 Vdc
Start-up Time: 10 msec max

1/ Frequency Aging Limits

Max change over 30 days  $\pm 1.5$  ppm Max change over 90 days  $\pm 3$  ppm

\* Enable, Logic 1 | Disable, Logic 0

Terminate any unused pads, (they are not terminated internally).

\*Code A, total overall stability vs. temperature of ±60 ppm includes ±20 ppm accuracy at +23°C

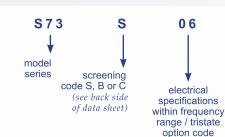
Model	Description					
EM: Engineering Models Same as FM, not with Class K radiation tolerant die commercial screen						
EQM: Engineering Qualification Models	Same as FM with Class K radiation tolerant die*, B or C level screening only					
FM: Flight Models	Class K radiation tolerant die*, screening & Group A					
	*unless specified otherwise					

Pin Number	Function
1	No Connect or TriState Enable
2	Ground (case)
3	Output
4	Supply V (Vcc)

Standard PIN CONFIGURATION

# How To ORDER

MIL-STD-790 Certified QPL per MIL-PRF-55310 ISO 9001:2015 Pb-free RoHS Certified

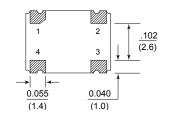


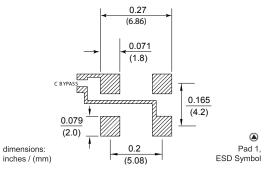
A - 1 M 0 0 0 0 0 0 output frequency stability code

example:
S73S06A-1M000000

### $0.276 \pm .006$ R 0.200 $(7.0 \pm 0.2)$ max (R.008) Frequency standard marking Part Number 0.197 ± .006 shown FMI YYWW $(5.00 \pm 0.15)$ $0.200 \pm .008$ $(5.08 \pm 0.2)$ 0.<u>079</u> max (2.0)

### **Mechanical SPECIFICATIONS**













Thru-hole Leaded 5x7 mm Ceramic SMD for Space, Please Inquire! New 5x3.2 Radiation Tolerant Oscillator for Space, Please Inquire!



**S53** 

Please request or	ur General Specification for
Class S Oscillators	Document # QP1100100

### **Options Available for FLIGHT MODELS**

MIL-STD-202

Groups B, C, & D per MIL-PRF-38534 (QCI or Qualification)

Groups B & C per MIL-PRF-55310 Single Lot Date Code
Data Packages Source Inspection
Swept Quartz Crystals HiRes Photography

#### **Environmental COMPLIANCE Environmental** Method Condition **Specification** Vibration - Sine 20g, 10 to 2 KHz MIL-STD-202 Method 204 Condition D Vibration - Random MIL-STD-202 Condition 1 30g rms, 10 to 2 KHz Random Method 214 Shock MIL-STD-202 Method 213 Condition I 100g, 6 ms, F:1500, 0.5 ms Seal Test MIL-STD-883 Method 1014 Condition A1 Fine Leak Seal Test MIL-STD-883 Method 1014 Condition C1 Gross Leak Temperature Cycling MIL-STD-883 Method 1010 Condition B 10 Cycles Minimum **Constant Acceleration** MIL-STD-883 Method 2001 Condition A 5000g, Y1 Axis

Method 107

Condition B

### continued...

Thermal Shock

Environmental	Specification	Method	Condition		
Ambient Pressure	MIL-STD-202	Method 105	Condition C		
Resistance to Soldering Heat	MIL-STD-202	Method 210	Condition C		
Moisture Resistance	MIL-STD-202	Method 106	with 7B Sub-cycle		
Salt Atmosphere (corrosion)	MIL-STD-883	Method 1009	Condition A (24 hrs)		
Terminal Strength	MIL-STD-202	Method 211	Test Condition D		
Solderability	MIL-STD-883	Method 2003			
Resistance to Solvents	MIL-STD-202	Method 215			

Screening	Method Level:	S	В	DE	
Non-Destruct Bond Pull	MIL-STD-883. Method 2023	3	D	Ī	
Internal Visual	MIL-STD-883, Method 2017, Class K; Method 2032		•	l	
iliterriai visuai	MIL-STD-883, Method 2017, Class H; Method 2032	•			
Stabilization (Vacuum) Bake	MIL-STD-883, Method 1008, Condition C, 150°C, 48 hours min			ı	
Stabilization (Vacuum) bake	MIL-STD-883, Method 1008, Condition C, 150°C, 24 hours min	•			
Temperature Cycling	MIL-STD-883, Method 1010, Condition B, 10 Cycles			ı	
Constant Acceleration	MIL-STD-883, Method 2001, Condition A (Y1 only, 5000 g's)	ľ	•	ı	
		•	•	l	
PIND Test	MIL-STD-883, Method 2020, Condition B, 5 passes max	•		ı	
Seal: Fine Leak	MIL-STD-883, Method 1014, Condition A1	•		l	
	MIL-STD-202, Method 112, Condition C, 111A		•	l	
Seal: Gross Leak	MIL-STD-202, Method 112, Condition D	•	•	ı	
Electrical Test	Functional Test Only at +23°C	•	•	l	
Marking & Serialization	MIL-STD-1285	•	•	ı	
Electrical Test	Nominal Vcc & Extremes and Nominal Temp and Extremes	•	•	l	
Burn-in (load)	+125°C, Nominal Supply Voltage and Burn-in load, 160 hours min	•	•	ı	
Burn-in (no-load)	+125°C, Nominal Supply Voltage and Burn-in load, 48 hours min			l	
Interim Electrical	Functional Test Only	•			
Burn-in (load) +125°C, Nominal Supply Voltage and Burn-in load, 160 hours min		•			
b) Frequency stability is tested extremes and at +25°C at a	ncy, output waveform, are tested at +23°C ±2°C dover the specified temperature range; at both a minimum of 5 temperature increments a is by lot # and then serial #	•	•		
Radiography	MIL-STD-883, Method 2012	•			
Frequency Aging	MIL-PRF-55310, +70°C Condition	•			
Frequency/Temperature Stability	MIL-PRF-55310, Over temperature extremes, 20 points equally spaced	•			
External Visual & Mechanical	MIL-STD-883, Method 2009			İ	

 $note: other\ options,\ screening\ levels\ and\ custom\ test\ plans\ available.$ 

MIL-STD-790 Certified QPL per MIL-PRF-55310 ISO 9001:2015 Pb-free RoHS Certified

### **Military Reference Specifications**

MIL-PRF-55310 Oscillators, Crystal Controlled, General Specification For
MIL-PRF-38534 Hybrid Microcircuits, General Specification For
Hybrid Microcircuits, General Specification For
Test Method Standard, Electronic and Electrical Components
Test Methods and Procedures for Microelectronics
MIL-STD-1686 Electrostatic Discharge Control Program for Protection of

Electrical and Electronic Parts, Assemblies and Equipment

### Materials

- 1. Package Materials: Ceramic, Alumina 90% min
- 2. Pad Plating Material: Gold Plate 0.3 μm (12 μ inch) over 2 μm (80 μ inch) min. Nickel

### **Products for Space Applications**

Contact us for assistance with your specification. We will provide you with the technical support and the required documentation.

Issue 11\_12192023



Ph. 714 373 8100 Fx. 714 373 8700